

Serial No. 10/090,806
February 10, 2004
Reply to the Office Action dated November 18, 2003
Page 6 of 8

REMARKS/ARGUMENTS

Claims 9-20 are pending in this Application.

Claims 9-11 and 14 were rejected under 35 U.S.C. § 102(b) as being anticipated by Person et al. (U.S. 5,321,573). Claims 12 and 13 were rejected under 35 U.S.C. § 103(a) as being unpatentable over Person et al. in view of Nagakubo et al. (U.S. 5,966,938). Claims 15-17 and 20 were rejected under 35 U.S.C. § 103(a) as being unpatentable over Person et al. Claims 18 and 19 were rejected under 35 U.S.C. § 103(a) as being unpatentable over Person et al. in view of Nagakubo et al. (U.S. 5,966,938). Applicants respectfully traverse the rejections of claims 9-20.

Claim 9 recites:

"A manufacturing method of a chip-type composite electronic component comprising the steps of:

forming an inductor characteristic sheet by laminating a ceramic layer having an internal coil conductor;

forming a thermistor characteristic sheet by laminating a ceramic layer having an internal electrode and having a predetermined resistance-temperature characteristic;

forming a compound multilayer body by adhering the inductor characteristic sheet and the thermistor characteristic sheet by pressure with a diffusion-prevention layer sandwiched therebetween;

baking a compound multilayer body;

forming external electrodes on an end surface of a compound multilayer body in which at least one end part of an internal coil conductor and at least one end part of an internal electrode are exposed." (emphasis added)

Applicants' claim 9 recites the step of "forming a thermistor characteristic sheet." Applicants' claim 15 recites method steps and features which are similar to the method steps and features recited in Applicants' claim 9, including the above emphasized features. With the improved method steps and features of claims 9 and 15, Applicants have been able to provide a method of manufacturing a small-sized chip-type composite electronic component in which the impedance can be changed depending upon the temperature (see, for example, the last full paragraph on page 1 of the Specification).

Serial No. 10/090,806
February 10, 2004
Reply to the Office Action dated November 18, 2003
Page 7 of 8

The Examiner has alleged that reference numbers 24 and 26 and line 28 of column 7 to line 16 of column 8 of Person et al. teaches the step of "forming a thermistor characteristic sheet" recited in Applicants' claims 9 and 15. Applicants respectfully disagree.

The Examiner is respectfully reminded that MPEP § 2121.01 states:

"In determining that quantum of prior art disclosure which is necessary to declare an applicant's invention 'not novel' or 'anticipated' within section 102, the stated test is whether a reference contains an 'enabling disclosure'... ." *In re Hoeksema*, 399 F.2d 269, 158 USPQ 596 (CCPA 1968). A reference contains an "enabling disclosure" if the public was in possession of the claimed invention before the date of invention.

Applicants respectfully submit that Person et al. is not enabling for the step of "forming a thermistor characteristic sheet" recited in Applicants' claims 9 and 15 because (1) reference numbers 24 and 26 are directed to varistors, **NOT thermistors** as recited in Applicants' claims 9 and 15; (2) the only mention of thermistors in Person et al. is in claims 11 and 12; and (3) Person et al. does not place Applicants' claimed invention in possession of the public because Person et al. only mentions thermistors in the claims and fails to provide any disclosure or teachings regarding thermistors. It appears that the recitation of the "thermistors" in claims 11 and 12 of Person et al. is nothing more than a typographical error, and should have been "varistors."

Thus, contrary to the Examiner's allegation, Person et al. fails to teach or suggest the step of "forming a thermistor characteristic sheet" as recited in Applicants' claims 9 and 15.

Accordingly, Applicants respectfully request reconsideration and withdrawal of the rejection of claim 9 under 35 U.S.C. § 102(b) as being anticipated by Person et al. and claim 15 under 35 U.S.C. 103(a) as being unpatentable over Person et al.

The Examiner has relied upon Nagakubo et al. to allegedly cure various deficiencies in Person et al. However, Nagakubo et al. fails to teach or suggest the feature of "forming a thermistor characteristic sheet" in combination with the other

Serial No. 10/090,806
February 10, 2004
Reply to the Office Action dated November 18, 2003
Page 8 of 8

method steps and features recited in Applicants' claims 9 and 15.

Accordingly, Applicants respectfully submit that Person et al. and Nagakubo et al., applied alone or in combination, fail to teach or suggest the unique combination and arrangement of elements recited in claims 9 and 15 of the present application. Claims 10-14 depend upon claim 9 and are therefore allowable for at least the reasons that claim 9 is allowable. Claims 16-20 depend upon claim 15 and are therefore allowable for at least the reasons that claim 15 is allowable.

In view of the foregoing remarks, Applicants respectfully submit that this application is in condition for allowance. Favorable consideration and prompt allowance are solicited.

The Commissioner is authorized to charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account No. 50-1353.

Respectfully submitted,

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